

## HD74LVC4245A

# Octal Bus Transceiver and 3.3 V to 5 V shifters with 3-state Outputs

REJ03D0378-0101 Rev.1.01 Apr. 13, 2005

#### **Description**

The HD74LVC4245A has eight bus transceivers with three state outputs in a 24 pin package. When (DIR) is high, data flows from the A inputs to the B outputs, and when (DIR) is low, data flows from the B inputs to the A outputs. A and B bus are separated by making enable input  $(\overline{OE})$  high level. And this product has two terminals  $(V_{CCA}, V_{CCB})$ ,  $V_{CCA}$  (5V) is connected with control input and A bus side,  $V_{CCB}$  (3.3V) connected with B bus side.  $V_{CCA}$  and  $V_{CCB}$  are isolated. This allows for translation from a 3.3 V to a 5 V environment, and vice versa. Low voltage and high-speed operation is suitable at the battery drive product (note type personal computer) and low power consumption extends the life of a battery for long time operation.

#### **Features**

- This product function as level shift transceiver that change V<sub>CCA</sub> input level to V<sub>CCB</sub> output level, V<sub>CCB</sub> input level to V<sub>CCA</sub> output level by providing different supply voltage to V<sub>CCA</sub> and V<sub>CCB</sub>.
- This product is able to the power management: Turn on and off the supply on V<sub>CCB</sub> side with providing the supply of V<sub>CCA</sub>. (Enable input (OE): High level )
- $V_{CCA} = 4.5 \text{ V}$  to 5.5 V,  $V_{CCB} = 2.7 \text{ V}$  to 3.6 V
- All control input  $V_I$  (max) = 5.5 V (@ $V_{CCA}$  = 0 V to 5.5 V)
- All A bus side input outputs  $V_{I/O}$  (max) = 5.5 V (@ $V_{CCA}$  = 0 V or output off state)
- All B bus side input outputs  $V_{I/O}$  (max) = 3.6 V (@ $V_{CCB}$  = 0 V or output off state)
- High output current

A bus side :  $\pm 24 \text{ mA} (@V_{CCA} = 4.5 \text{ V to } 5.5 \text{ V})$ 

B bus side :  $\pm 12 \text{ mA } (@V_{CCB} = 2.7 \text{ V})$ 

 $\pm 24 \text{ mA} (@V_{CCB} = 3.0 \text{ V to } 3.6 \text{ V})$ 

Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)
HD74LVC4245ATEL	TSSOP-24 pin	PTSP0024JB-A (TTP-24DBV)	Т	EL (1,000 pcs/reel)

#### **Function Table**

Inp		
ŌĒ	DIR	Operation
L	L	B data to A bus
L	Н	A data to B bus
Н	X	Z

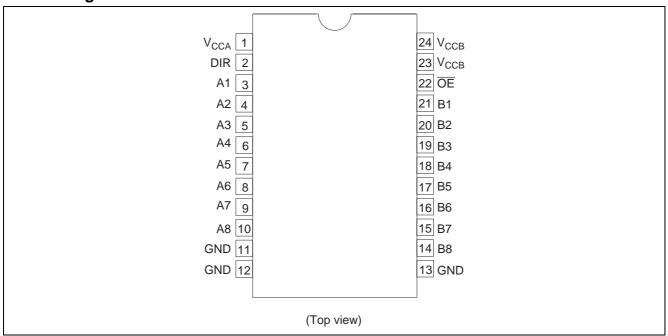
H: High level

L: Low level

X: Immaterial

Z: High impedance

#### **Pin Arrangement**



### **Absolute Maximum Ratings**

(1) For  $V_{CCA}$ 

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CCA</sub>	-0.5 to 6.0	V	
Input voltage*1	Vı	-0.5 to 6.0	V	DIR, ŌE
Input / output voltage	V <sub>I/O</sub>	-0.5 to V <sub>CCA</sub> +0.5	V	A port output "H" or "L"
		-0.5 to 6.0		A port output "Z" or V <sub>CCA</sub> : OFF
Input diode current	I <sub>IK</sub>	-50	mA	V <sub>I</sub> < 0
Output diode current	I <sub>OK</sub>	-50	mA	V <sub>O</sub> < 0
		50		V <sub>O</sub> > V <sub>CCA</sub> +0.5
Output current	I <sub>0</sub>	±50	mA	
V <sub>CCA</sub> , GND current	I <sub>CCA</sub> or I <sub>GND</sub>	100	mA	
Maximum power dissipation at Ta = 25°C (in still air) <sup>*2</sup>	P <sub>T</sub>	862	mW	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

(2) For  $V_{\text{CCB}}$ 

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CCB</sub>	-0.5 to 4.6	V	
Input / output voltage*1	V <sub>I/O</sub>	-0.5 to V <sub>CCB</sub> +0.5	V	B port output "H" or "L"
		-0.5 to 4.6		B port output "Z" or V <sub>CCB</sub> : OFF
Input diode current	I <sub>IK</sub>	-50	mA	V <sub>1</sub> < 0
Output diode current	I <sub>OK</sub>	-50	mA	V <sub>O</sub> < 0
		50		$V_O > V_{CCB} + 0.5$
Output current	Io	±50	mA	
V <sub>CCB</sub> ,GND current	I <sub>CCB</sub> or I <sub>GND</sub>	100	mA	
Maximum power dissipation at Ta = 25°C (in still air) <sup>*2</sup>	P <sub>T</sub>	862	mW	TSSOP
Storage temperature	Tstg	-65 to 150	°C	

Notes: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

- 1. The input and output voltage ratings may be exceeded even if the input and output clamp-current ratings are observed.
- 2. The maximum package power dissipation was calculated using a junction temperature of 150°C.

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## **Recommended Operating Conditions**

(1) For  $V_{CCA}$ 

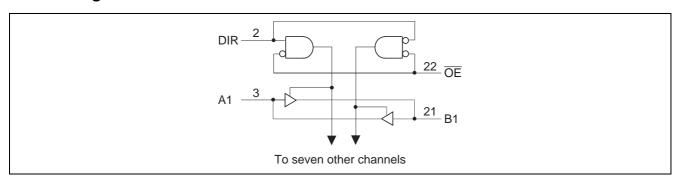
Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CCA</sub>	4.5 to 5.5	V	
Input / output voltage	VI	0 to 5.5	V	DIR, ŌE
	V <sub>I/O</sub>	0 to V <sub>CCA</sub>		A port output "H" or "L"
		0 to 5.5		A port output "Z" or V <sub>CCA</sub> : OFF
Output current	I <sub>OH</sub>	-24	mA	
	I <sub>OL</sub>	24		
Input transition rise or fall time	Δt / Δν	10	ns / V	
Operating temperature	Та	-40 to 85	°C	

(2) For  $V_{\text{CCB}}$ 

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CCB</sub>	2.7 to 3.6	V	
Input / output voltage	V <sub>I/O</sub>	0 to V <sub>CCB</sub>	V	B port output "H" or "L"
		0 to 3.6		B port output "Z" or V <sub>CCB</sub> : OFF
Output current	I <sub>OH</sub>	-12	mA	V <sub>CCB</sub> = 2.7 V
		-24		V <sub>CCB</sub> = 3.0 to 3.6 V
	I <sub>OL</sub>	12		V <sub>CCB</sub> = 2.7 V
		24		V <sub>CCB</sub> = 3.0 to 3.6 V
Input transition rise or fall time	Δt / Δν	10	ns / V	
Operating temperature	Та	-40 to 85	°C	

Note: Unused or floating inputs must be held high or low.

### **Block Diagram**



#### **Electrical Characteristics**

 $(Ta = -40 \text{ to } 85^{\circ}C)$ 

Item	Symbol	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Max	Unit	Test Conditions
Input voltage	V <sub>IH</sub>	4.5 to 5.5	2.7 to 3.6	2	_	V	
	V <sub>IL</sub>	4.5 to 5.5	2.7 to 3.6	_	0.8		
Output voltage	V <sub>OHA</sub>	4.5 to 5.5	2.7 to 3.6	V <sub>CCA</sub> -0.2	_	V	$I_{OH} = -100 \mu A$
		4.5	2.7 to 3.6	3.7			I <sub>OH</sub> = -24 mA
		5.5	2.7 to 3.6	4.7			
	V <sub>OHB</sub>	4.5 to 5.5	2.7 to 3.6	V <sub>CCB</sub> -0.2	_	V	$I_{OH} = -100 \mu A$
		4.5 to 5.5	2.7	2.2			I <sub>OH</sub> = -12 mA
		4.5 to 5.5	3.0	2.4			
		4.5 to 5.5	3.0	2	_		I <sub>OH</sub> = -24 mA
	V <sub>OLA</sub>	4.5 to 5.5	2.7 to 3.6	_	0.2	V	$I_{OL} = 100  \mu A$
		4.5	2.7 to 3.6	_	0.55		I <sub>OL</sub> = 24 mA
		5.5	2.7 to 3.6	_	0.55		
	V <sub>OLB</sub>	4.5 to 5.5	2.7 to 3.6	_	0.2	V	$I_{OL} = 100 \ \mu A$
		4.5 to 5.5	2.7	_	0.4		I <sub>OL</sub> = 12 mA
		4.5 to 5.5	3.0	_	0.55		I <sub>OL</sub> = 24 mA
Input current	I <sub>IN</sub>	5.5	2.7 to 3.6	_	±1	μΑ	Control input
Off state	I <sub>OZA</sub>	5.5	2.7 to 3.6	_	±5	μΑ	A port, $V_O = V_{CCA}$ or GND
output current	I <sub>OZB</sub>	4.5 to 5.5	3.6	_	±5		B port, $V_O = V_{CCB}$ or GND
Output leak current	l <sub>OFF</sub>	0	0	_	20	μА	A port, $V_{I/O} = 5.5 \text{ V}$ B port, $V_{I/O} = 3.6 \text{ V}$
Quiescent supply current	I <sub>CCA</sub>	5.5	2.7 to 3.6	_	80	μА	B to A, control input =V <sub>CCA</sub> or GND Bn = V <sub>CCB</sub> or GND, I <sub>O</sub> (A port) = 0
	Іссв	4.5 to 5.5	3.6	_	50	μΑ	A to B, control input = $V_{CCA}$ or GND An = $V_{CCA}$ or GND, I <sub>O</sub> (B port) = 0
Increase in I <sub>CC</sub> per input *1	Δl <sub>CCA</sub>	5.5	2.7 to 3.6	_	1.5	mA	A port or Control input, One input at 3.4 V, Other input at V <sub>CCA</sub> at GND
	ΔІссв	4.5 to 5.5	2.7 to 3.6		0.5	mA	B port, One input at V <sub>CCB</sub> –0.6V, Other input at V <sub>CCB</sub> at GND

Notes: For condition shown as Min or Max, use the appropriate values under recommended operating conditions.

<sup>1.</sup> This is the increase in supply current for each input that is at the specified TTL voltage level rather than  $V_{CC}$  or GND.

#### Capacitance

 $(Ta = 25^{\circ}C)$ 

Item	Symbol	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Тур	Max	Unit	Test Conditions
Control Input capacitance	C <sub>IN</sub>	5	3.3		5		рF	$V_I = V_{CCA}$ or GND
Input/output capacitance	C <sub>I/O</sub>	5	3.3	_	11	_	-	A port, $V_I = V_{CCA}$ or GND, B port, $V_I = V_{CCB}$ or GND

#### **Switching Characteristics**

 $(Ta = -40 \text{ to } 85^{\circ}\text{C}), V_{CCA} = 5.0 \pm 0.5 \text{ V}, V_{CCB} = 2.7 \text{ V to } 3.6 \text{ V})$ 

Item	Symbol	Min	Тур	Max	Unit	Test conditions	From(Input)	To(Output)
Propagation delay	t <sub>PLH</sub>	1	_	6.7	ns	$C_L = 50 \text{ pF}$	Α	В
time	t <sub>PHL</sub>	1	_	6.3		$R_L = 500 \Omega$		
	t <sub>PLH</sub>	1	_	5			В	Α
	t <sub>PHL</sub>	1	_	6.1				
Output enable time	t <sub>ZH</sub>	1	_	8.1	ns	$C_L = 50 \text{ pF}$	ŌĒ	Α
	t <sub>ZL</sub>	1	_	9		$R_L = 500 \Omega$		
	t <sub>ZH</sub>	1	_	9.8			ŌĒ	В
	t <sub>ZL</sub>	1	_	8.8				
Output disable time	t <sub>HZ</sub>	1	_	5.8	ns	$C_L = 50 pF$	ŌĒ	A
	$t_{LZ}$	1	_	7		$R_L = 500 \Omega$		
	t <sub>HZ</sub>	1	_	7.8	1		ŌĒ	В
	$t_{LZ}$	1	_	7.7				

#### **Operating Characteristics**

Item	Symbol	V <sub>CCA</sub> (V)	V <sub>CCB</sub> (V)	Min	Тур	Max	Unit	Test Conditions
Power dissipation capacitance	$C_{PD}$	5.0	3.0		39.5	_	pF	$f = 10 \text{ MHz}, C_L = 0$

#### **Power-up considerations**

Level-translation devices offer an opportunity for successful mixed-voltage signal design.

A proper power-up sequence always should be followed to avoid excessive supply current, bus contention, oscillations, or other anomalies caused by improperly biased device pins.

Take these precautions to guard against such power-up problems.

- 1. Connect ground before any supply voltage is applied.
- 2. Next, power up the control side of the device.

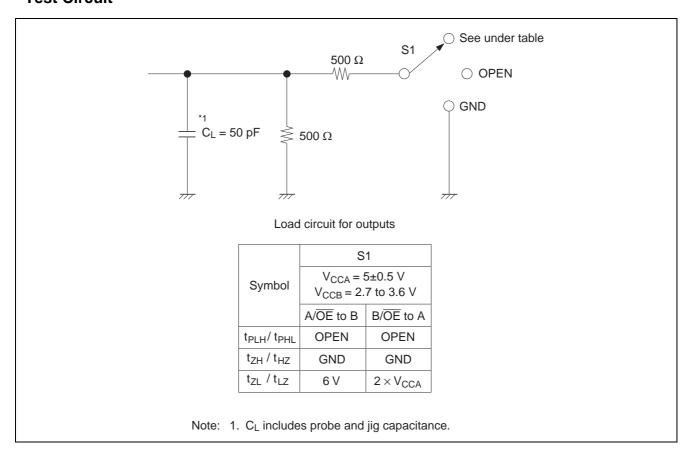
(Power up of  $V_{CCA}$  is first. Next power up is  $V_{CCB}$ .)

- 3. Tie  $\overline{OE}$  to  $V_{CCA}$  with a pullup resistor so that it ramps with  $V_{CCA}$ .
- 4. Depending on the direction of the data path, DIR can be high or low.

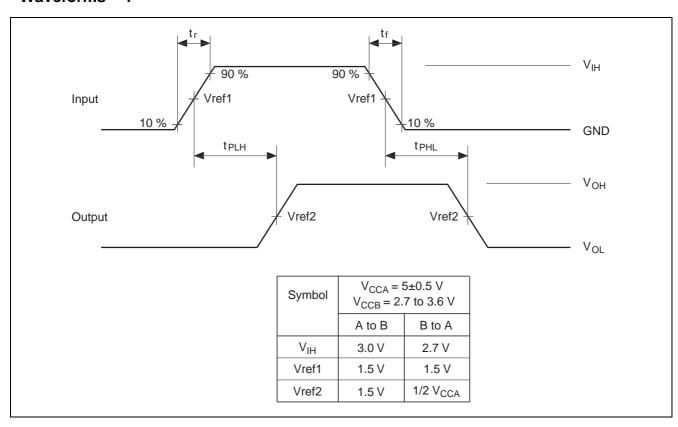
If DIR high is needed (A data to B bus), ramp it with  $V_{\text{CCA}}$ . Overwise, keep DIR low.



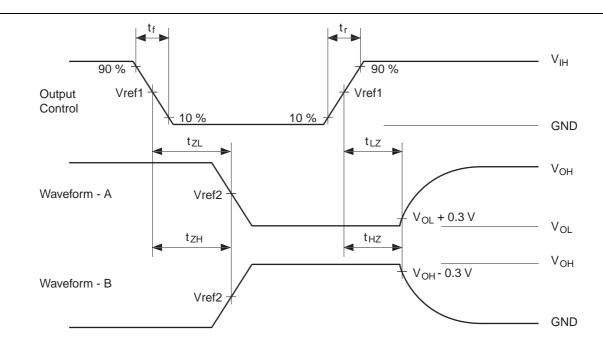
#### **Test Circuit**



#### Waveforms - 1



#### Waveforms - 2

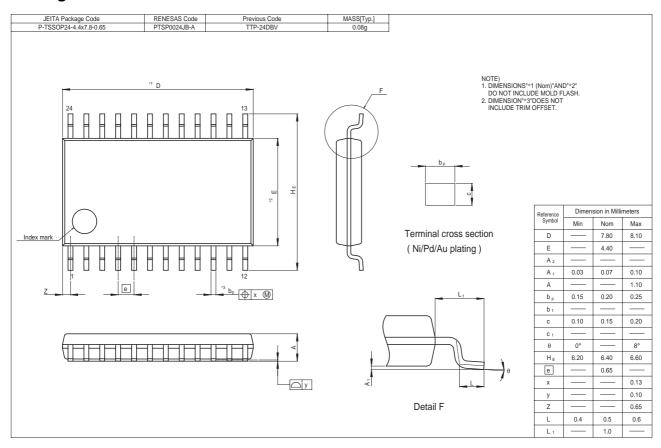


Symbol	$V_{CCA} = 5\pm0.5 \text{ V}$ $V_{CCB} = 2.7 \text{ to } 3.6 \text{ V}$					
	OE to B	OE to A				
V <sub>IH</sub>	3.0 V	3.0 V				
Vref1	1.5 V	1.5 V				
Vref2	1.5 V	1/2 V <sub>CCA</sub>				

Notes: 1. All input pulses are supplied by generators having the following characteristics : PRR  $\leq$  10 MHz,  $Z_O$  = 50  $\Omega,\,t_f\leq$  2.5 ns,  $t_f\leq$  2.5 ns.

- 2. Waveform A is for an output with internal conditions such that the output is low except when disabled by the output control.
- 3. Waveform B is for an output with internal conditions such that the output is high except when disabled by the output control.
- 4. The output are measured one at a time with one transition per measurement.

### **Package Dimensions**



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